RoHS

HALOGEN

FREE GREEN



# Vishay Semiconductors

# RGBW Color Sensor with I<sup>2</sup>C Interface



#### **DESCRIPTION**

VEML6040 color sensor senses red, green, blue, and white light and incorporates photodiodes, amplifiers, and analog / digital circuits into a single chip using CMOS process. With the color sensor applied, the brightness, and color temperature of backlight can be adjusted base on ambient light source that makes panel looks more comfortable for end user's eyes. VEML6040's adoption of Filtron<sup>TM</sup> technology achieves the closest ambient light spectral sensitivity to real human eye responses.

VEML6040 provides excellent temperature compensation capability for keeping the output stable under changing temperature. VEML6040's function are easily operated via the simple command format of I<sup>2</sup>C (SMBus compatible) interface protocol. VEML6040's operating voltage ranges from 2.5 V to 3.6 V. VEML6040 is packaged in a lead (Pb)-free 4 pin OPLGA package which offers the best market-proven reliability.

#### **FEATURES**

- Package type: surface mount
- Dimensions (L x W x H in mm): 2.0 x 1.25 x 1.0
- Integrated modules: color sensor (RGBW) and signal conditioning IC
- Filtron<sup>TM</sup> technology provides a spectrum matching real human eye responses
- Supports low transmittance (dark) lens design
- · Fluorescent light flicker immunity
- Provides 16-bit resolution for each channel (R, G, B, W)
- Selectable maximum detection range (360, 721, 1442, 2883, 5767, or 11 796) lux with highest sensitivity 0.0056 lux/step
- Package: OPLGA
- Temperature compensation: -40 °C to +85 °C
- Low power consumption I<sup>2</sup>C (SMBus compatible) interface
- Output type: I2C bus
- Operation voltage: 2.5 V to 3.6 V
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Handheld device
- Notebook
- Consumer device
- Industrial and mechanical application

PRODUCT SUMMARY							
PART NUMBER	OPERATING VOLTAGE RANGE (V)	I <sup>2</sup> C BUS VOLTAGE RANGE (V)	PEAK SENSITIVITY (nm)	RANGE OF SPECTRAL BANDWIDTH $\lambda_{0.5}$ (nm)	OUTPUT CODE		
VEML6040	2.5 to 3.6	1.7 to 3.6	650, 550, 450 (R, G, B)	± 35, ± 35, ± 40 (R, G, B)	16 bit, I <sup>2</sup> C		

#### Note

(1) Adjustable through I<sup>2</sup>C interface

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS
VEML6040A3OG	Tape and reel	MOQ: 2500 pcs	2.0 mm x 1.25 mm x 1.0 mm

#### Note

(1) MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT	
Supply voltage		$V_{DD}$	0	3.6	V	
Operation temperature range		T <sub>amb</sub>	-40	+85	°C	
Storage temperature range		T <sub>stg</sub>	-40	+85	°C	

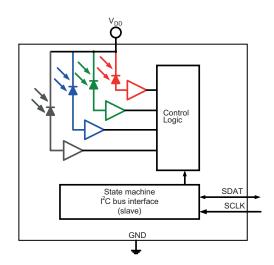
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<b>RECOMMENDED OPERATING CONDITIONS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT		
Supply voltage		$V_{DD}$	2.5	3.6	V		
Operation temperature range		T <sub>amb</sub>	-40	+85	°C		
I <sup>2</sup> C bus operating frequency		f <sub>(I2CCLK)</sub>	10	400	kHz		

PIN DESCRIPTIONS						
PIN ASSIGNMENT	SYMBOL	TYPE	FUNCTION			
1	GND	I	Ground			
2	SDAT	I / O (open drain)	I <sup>2</sup> C data bus data input / output			
3	SCLK	I	I <sup>2</sup> C digital bus clock input			
4	$V_{DD}$	I	Power supply input			

#### **BLOCK DIAGRAM**



BASIC CHARA	CTERISTI	<b>CS</b> ( $T_{amb} = 25  ^{\circ}C$ , unless other	erwise spe	cified)				
PARAMETER		TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Supply voltage			$V_{DD}$	2.5		3.6	V	
Supply current			I <sub>DD</sub>		200		μA	
	Logic high	V <sub>DD</sub> = 3.3 V	$V_{IH}$	1.5			V	
I <sup>2</sup> C signal input	Logic low	V <sub>DD</sub> = 3.3 V	$V_{IL}$			0.8	ď	
i o signai input	Logic high	V <sub>DD</sub> = 2.6 V	$V_{IH}$	1.4			V	
	Logic low	V <sub>DD</sub> = 2.0 V	$V_{IL}$			0.6	v	
			$\lambda_{PR}$		650		nm	
Peak sensitivity wave	elength		$\lambda_{PG}$		550		nm	
			$\lambda_{PB}$		450		nm	
		$\lambda_{PR} = 630 \text{ nm}$			180			
Irradiance responsivi	ty	$\lambda_{PG} = 530 \text{ nm}$			144		LSB/(µW/cm <sup>2</sup> )	
		$\lambda_{PB} = 467 \text{ nm}$			52			
Detectable intensity Minimum Maximum		G channel, I <sub>T</sub> = 1280 ms <sup>(1)(2)</sup>			0.0056			
		G channel, I <sub>T</sub> = 40 ms <sup>(1)(2)</sup>		11 796			- lx	
Dark offset		G channel, I <sub>T</sub> = 80 ms <sup>(1)</sup>		0		3		
Operating temperatu	re range		T <sub>amb</sub>	-40		+85	°C	
Shutdown current		Light condition = dark, V <sub>DD</sub> = 3.6 V	I <sub>DD</sub>		800		nA	

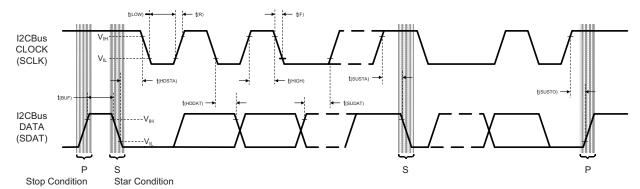
#### Notes

 $<sup>^{(1)}</sup>$  Test condition:  $V_{DD}$  = 3.3 V, temperature:  $25^{\circ}C$ 

<sup>(2)</sup> Light source: white LED



I <sup>2</sup> C BUS TIMING CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	SYMBOL	STANDA	RD MODE	FAST	MODE	UNIT
PARAMETER	STINIBUL	MIN.	MAX.	MIN.	MAX.	UNII
Clock frequency	f <sub>(SMBCLK)</sub>	10	100	10	400	kHz
Bus free time between start and stop condition	t <sub>(BUF)</sub>	4.7		1.3		μs
Hold time after (repeated) start condition; after this period, the first clock is generated	t <sub>(HDSTA)</sub>	4.0		0.6		μs
Repeated start condition setup time	t <sub>(SUSTA)</sub>	4.7		0.6		μs
Stop condition setup time	t <sub>(SUSTO)</sub>	4.0		0.6		μs
Data hold time	t <sub>(HDDAT)</sub>	200		90		ns
Data setup time	t <sub>(SUDAT)</sub>	250		100		ns
I <sup>2</sup> C clock (SCK) low period	t <sub>(LOW)</sub>	4.7		1.3		μs
I <sup>2</sup> C clock (SCK) high period	t <sub>(HIGH)</sub>	4.0		0.6		μs
Detect clock / data low timeout	t <sub>(TIMEOUT)</sub>	25	35			ms
Clock / data fall time	t <sub>(F)</sub>		300		300	ns
Clock / data rise time	t <sub>(R)</sub>		1000		300	ns



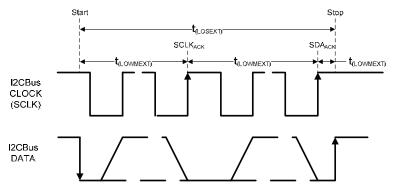


Fig. 1 -  $I^2C$  Bus Timing Diagram

#### PARAMETER TIMING INFORMATION

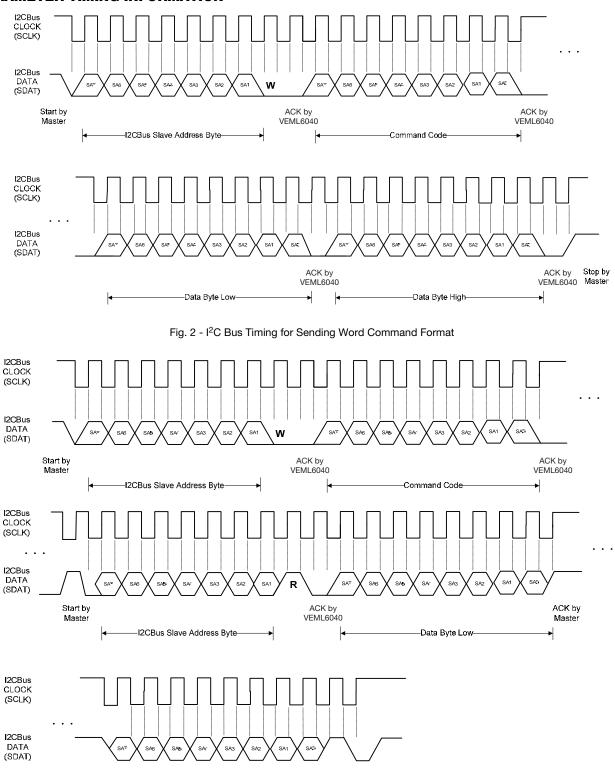


Fig. 3 - I<sup>2</sup>C Bus Timing for Receiving Word Command Format

ACK by

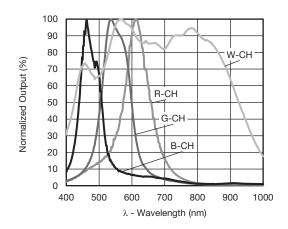
Master

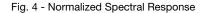
Stop by Master

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-Data Byte High-

#### **TYPICAL PERFORMANCE CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)





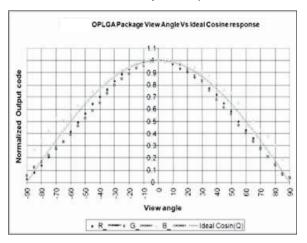


Fig. 5 - Normalized Output vs. View Angle

#### **APPLICATION INFORMATION**

#### Pin Connection with the Host

VEML6040 integrates R, G, B, and W sensor together with I<sup>2</sup>C interface. It is very easy for the baseband (CPU) to access VEML6040 output data via I<sup>2</sup>C interface without extra software algorithms. The hardware schematic is shown in the following diagram.

The 0.1  $\mu$ F capacitor near the  $V_{DD}$  pin is used for power supply noise rejection. The 2.2  $k\Omega$ s are suitable for the pull-up resistors of  $l^2C$ .

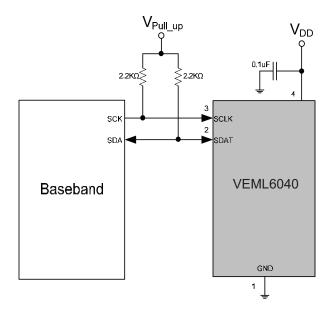


Fig. 6 - Hardware Pin Connection Diagram



#### **Digital Interface**

VEML6040 apply slave address 0x10 of 7 bit addressing protocol for I<sup>2</sup>C. VEML6040 contains an 8-bit command register following each of slave address as shown in figure 7. All operations can be controlled by the command register. The simple command structure helps users easily program the operation setting and latch the light data from VEML6040. Following I<sup>2</sup>C command format is simple for read and write operations between VEML6040 and the host as shown in figure 7. The white sections indicate host activity and the gray sections indicate VEML6040's acknowledgement of the host access activity. Based on write word protocol, 8-bit command codes can be written by the host under the same slave address. For data reading, VEML6040 apply read word protocol.

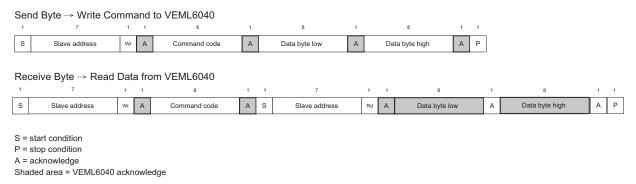


Fig. 7 - Command Protocol Format

#### **Slave Address and Function Description**

VEML6040 uses 0x10 slave address for 7-bit I<sup>2</sup>C addressing protocol. VEML6040 has 16-bit resolution for each channel (R, G, B, and W) that provides sensitivity up to 0.0056 lux/step for G, which is advantageous under a low transmittance lens design (dark lens).

TABLE 1	TABLE 1 - SLAVE ADDRESS AND COMMAND CODE DESCRIPTION									
	SLAVE ADDRESS 0x10									
COMMAND	REGISTER	R/W				В	IT			
CODE	NAME	n/W	7	6	5	4	3	2	1	0
00H_L	CONF	R/W	0		IT (2:0)		0	TRIG	AF	SD
00H_H	Reserved	R/W	Reserved							
01H to 07H	Reserved	R/W	Reserved							
08H_L	R_DATA_L	R	R_Data (7	: 0)						
08H_H	R_DATA_M	R	R_Data (1	5 : 8)						
09H_L	G_DATA_L	R	G_Data (7	': 0)						
09H_H	G_DATA_M	R	G_Data (1	5:8)						
0AH_L	B_DATA_L	R	B_Data (7	: 0)						
0AH_H	B_DATA_M	R	B_Data (1	5 : 8)						
0BH_L	W_DATA_L	R	W_Data (7	7:0)					•	
0BH_H	W_DATA_M	R	W_Data (1	15 : 8)						

#### Note

Slave address is 7-bit addressing protocol



#### **Command Register Format**

VEML6040 provides an 8-bit command register for controlling. The description of each command format is shown in the following tables. Color sensor is function compatible with ambient light sensor when apply color sensor at green channel.

#### **Color Sensor Command**

TABLE 2-1	TABLE 2-1 - COMMAND CODE 00H BITS DESCRIPTION								
	SLAVE ADDRESS: 0x10; REGISTER NAME: CONF; COMMAND CODE: 00H / DATA BYTE LOW								
Х		IT		Х	TRIG	AF	SD		
BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0		
0	IT2	IT1	IT0	0	TRIG	AF	SD		
			DESCF	RIPTION	•				
	IT	Integration time	e setting						
TI	RIG	Proceed one d	Proceed one detecting cycle at manual force mode						
A	AF.	Auto / manual t	Auto / manual force mode						
5	SD	Chip shutdown	setting						

TABLE 2-2 - COMMAND CODE 00H REGISTER SETTING						
BITS SETTING	DESCRIPTION	BITS SETTING	DESCRIPTION			
BIT 7	Default = 0	BIT 3	Default = 0			
	(0 : 0 : 0) = 40 ms	BIT 2	0 = no trigger			
	(0:0:1) = 80 ms	TRIG	1 = trigger one time detect cycle			
BIT 6, 5, 4	(0 : 1 : 0) = 160 ms	BIT 1	0 = auto mode			
IT (2 : 0)	(0 : 1 : 1) = 320 ms	AF	1 = force mode			
	(1 : 0 : 0) = 640 ms	BIT 0	0 = enable color sensor			
	(1 : 0 : 1) = 1280 ms	SD	1 = disable color sensor			

TABLE 3-1 - RESERVE COMMAND CODE DESCRIPTION					
RESERVED		COMMAND CODE: 00H / DATA BYTE HIGH			
Command	Bit	Description			
Reserved	7:0	Default = 00H			

TABLE 3-2 - RESERVE COMMAND CODE DESCRIPTION					
RESERVED		COMMAND CODE: 01H TO 07H			
Command	Bit	Description			
Reserved	7:0	Default = 00H			

TABLE 4 - READ OUT COMMAND CODE DESCRIPTION							
COMMAND CODE	REGISTER	BIT	DESCRIPTION				
08H_L (08H data byte low)	R_DATA_L	7:0	00H to FFH, R channel LSB output data				
08H_H (08H data byte high)	R_DATA_M	7:0	00H to FFH, R channel MSB output data				
09H_L (09H data byte low)	G_DATA_L	7:0	00H to FFH, G channel LSB output data				
09H_H (09H data byte high)	G_DATA_M	7:0	00H to FFH, G channel MSB output data				
0AH_L (0AH data byte low)	B_DATA_L	7:0	00H to FFH, B channel LSB output data				
0AH_H (0AH data byte high)	B_DATA_M	7:0	00H to FFH, B channel MSB output data				
0BH_L (0BH data byte low)	W_DATA_L	7:0	00H to FFH, W channel LSB output data				
0BH_H (0BH data byte high)	W_DATA_M	7:0	00H to FFH, W channel MSB output data				



#### **Data Access**

VEML6040 has 16-bit high resolution sensitivity for each channel of color sensor (R,G,B, and W). To represent the 16-bit data, it has to apply two bytes. One byte is for LSB and the other byte is for MSB. The host needs to follow the read word protocol as shown in figure 7. The data format shows as below.

TABLE 5 - 16-BIT DATA FORMAT															
VEML6040 16-BIT DATA FORMAT															
1 0	2	3	4	5	6	7	8	9	10	11	12	13	14	15	Data bit
-						-									Data byte low
							<b>-</b>							•	Data byte high
lotes															
							<b>-</b>								Data byte high Notes

- Data byte low represents LSB and data byte high represents MSB.
- To read color data, for example, R channel the following should be written: 10H-08H-11H and then the 16 bit result is available. Command code for R, G, B, and W channel data is 08H, 09H, 0AH, and 0BH respectively.

The integration time settings result in the corresponding resolutions that are shown in table 6.

ABLE 6 - G CHANNEL RESOLUTION AND MAXIMUM DETECTION RANGE						
IT :	G SENSITIVITY					
IT (2 : 0)	INTEGRATION TIME	G SENSITIVITY				
(0:0:0)	40 ms	0.18				
(0:0:1)	80 ms	0.09				
(0 : 1 : 0)	160 ms	0.045				
(0 : 1 : 1)	320 ms	0.0225				
(1:0:0)	640 ms	0.01125				
(1:0:1)	1280 ms	0.005625				
G integrati	11 796 lux					

#### **Data Auto-Memorization**

VEML6040 can memorize the last ambient light data before shutting down and keeps this data before waking up again. When VEML6040 is in shutdown mode, the host can freely read this data directly via read command. When VEML6040 wakes up, the data is refreshed by a newly acquired detection.

-30um ± 10 um

 $\square_{0.1}$ 

# Vishay Semiconductors

2 SDAT3 SCLK

(4) VDD

Unit: mm

#### **PACKAGE INFORMATION** in millimeters

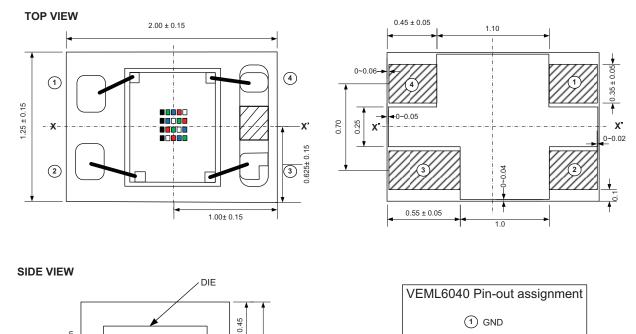


Fig. 8 - VEML6040 A3OG Package Dimensions

#### **LAYOUT NOTICE AND REFERENCE CIRCUIT** in millimeters

0.56

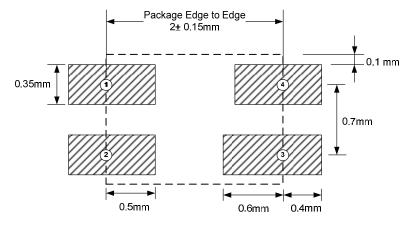


Fig. 9 - VEML6040 PCB Layout Footprint



#### **APPLICATION CIRCUIT BLOCK REFERENCE**

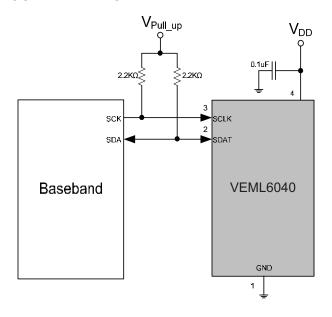


Fig. 10 - VEML6040 Application Circuit

RECOMMENDED STORAGE AND REBAKING CONDITIONS							
PARAMETER	CONDITIONS	MIN.	MAX.	UNIT			
Storage temperature		5	50	°C			
Relative humidity			60	%			
Open time			168	h			
Total time	From the date code on the aluminized envelope (unopened)		12	months			
Rebaking	Tape and reel: 60 °C		22	h			
	Tube: 60 °C		22	h			

#### **RECOMMENDED INFRARED REFLOW**

Soldering conditions which are based on J-STD-020 C

IR REFLOW PROFILE CONDITION								
PARAMETER	CONDITIONS	TEMPERATURE	TIME					
Peak temperature		255 °C + 0 °C / - 5 °C (max.: 260 °C)	10 s					
Preheat temperature range and timing		150 °C to 200 °C	60 s to 180 s					
Timing within 5 °C to peak temperature			10 s to 30 s					
Timing maintained above temperature / time		217 °C	60 s to 150 s					
Timing from 25 °C to peak temperature			8 min (max.)					
Ramp-up rate		3 °C/s (max.)						
Ramp-down rate		6 °C/s (max.)						



Recommend Normal Solder Reflow is 235 °C to 255 °C

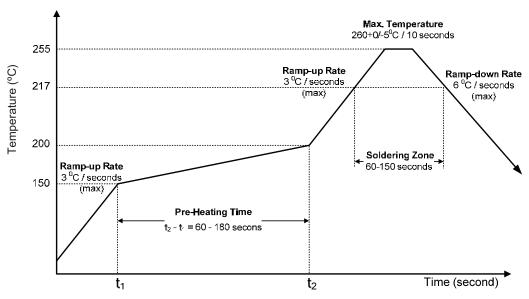


Fig. 11 - VEML6040 OPLGA Solder Reflow Profile Chart

#### RECOMMENDED IRON TIP SOLDERING CONDITION AND WARNING HANDLING

- 1. Solder the device with the following conditions:
  - 1.1. Soldering temperature: 400 °C (max.)
  - 1.2. Soldering time: 3 s (max.)
- 2. If the temperature of the method portion rises in addition to the residual stress between the leads, the possibility that an open or short circuit occurs due to the deformation or destruction of the resin increases.
- 3. The following methods: VPS and wave soldering, have not been suggested for the component assembly.
- 4. Cleaning method conditions:
  - 4.1. Solvent: methyl alcohol, ethyl alcohol, isopropyl alcohol
  - 4.2. Solvent temperature < 45 °C (max.)
  - 4.3. Time: 3 min (min.)



#### TAPE PACKAGING INFORMATION in millimeters

# DIMENSION OF CARRIER TAPE SIDE VIEW TOP VIEW 400±0.10

Fig. 12 - VEML6040 A3OG Package Carrier Tape

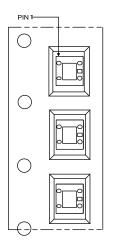


Fig. 13 - Taping Direction

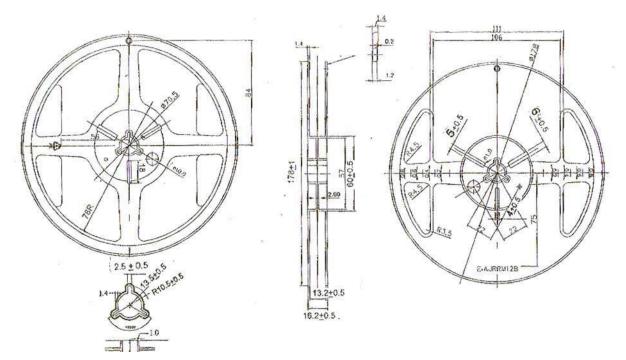


Fig. 14 - Reel Dimensions



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Revision: 02-Oct-12 Document Number: 91000

# AMEYA360 Components Supply Platform

# **Authorized Distribution Brand:**

























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